



#### 20V N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
20V	0.99Ω @V <sub>GS</sub> = 4.5V	530mA
	1.2Ω @Vgs = 2.5V	480mA
	1.8Ω @V <sub>GS</sub> = 1.8V	400mA
	2.4Ω @V <sub>GS</sub> = 1.5V	340mA

### **Description**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

### **Applications**

- General-purpose interfacing switches
- · Power-management functions
- Analog switches

## **Features and Benefits**

- Low Package Profile, 0.4mm Maximum Package Height
- 0.62mm × 0.62mm Package Footprint
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V max
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

  https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

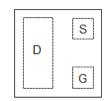
- Package: X2-DFN0606-3
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.001 grams (Approximate)





**Bottom View** 

G Gate Protection S Diode



**Equivalent Circuit** 

Top View Package Pin Configuration

## **Ordering Information** (Note 4)

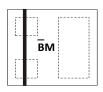
Part Number	Paakaga	Packing		
Part Number	Package	Qty.	Carrier	
DMN2992UFZ-7B	X2-DFN0606-3	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

#### X2-DFN0606-3



BM = Product Type Marking Code

Top View Bar Denotes Gate and Source Side



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	20	V		
Gate-Source Voltage	Vgss	±8	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25$ °C $T_A = +85$ °C	lD	530 430	mA
Pulsed Drain Current (Note 6)			Ірм	1500	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	Steady State	PD	420	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	295	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

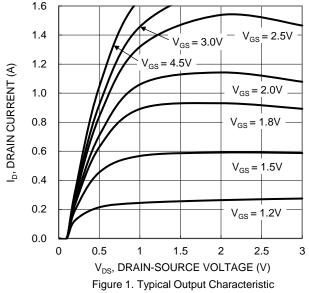
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	_	_	100	nA	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±200	nA	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	0.4	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
		_	0.4	0.99	Ω	Vgs = 4.5V, ID = 100mA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	0.5	1.2		Vgs = 2.5V, ID = 50mA
Static Diain-Source On-Resistance		_	0.6	1.8		$V_{GS} = 1.8V, I_{D} = 20mA$
		_	0.7	2.4		Vgs = 1.5V, ID = 10mA
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	15.6	_	pF	
Output Capacitance	Coss	_	5.4	_	pF	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	4	_	pF	1 - 1.00112
Total Gate Charge	Qg	_	0.41	_	nC	V 45V V 40V
Gate-Source Charge	Qgs	_	0.07	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$
Gate-Drain Charge	$Q_{gd}$	_	0.12	_	nC	10 - 23011A
Turn-On Delay Time	t <sub>D(ON)</sub>	_	1.77	_	ns	\/ 10\/ \/ 4.5\/
Turn-On Rise Time	t <sub>R</sub>	_	4.5		ns	$V_{DD} = 10V, V_{GS} = 4.5V,$ $R_{L} = 47\Omega, R_{G} = 10\Omega,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	22	_	ns	$-RL = 47\Omega$ , $RG = 10\Omega$ , -ID = 200 mA
Turn-Off Fall Time	tF	_	8.2	_	ns	10 - 200111A

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%. 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





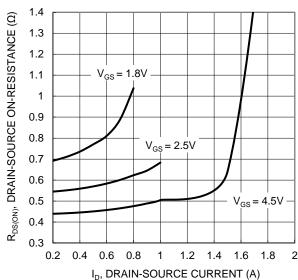


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

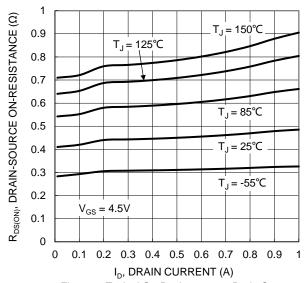
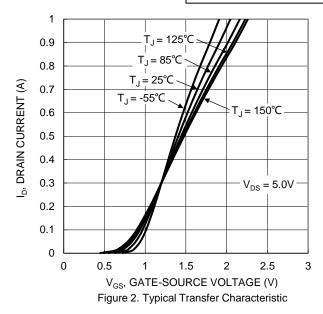
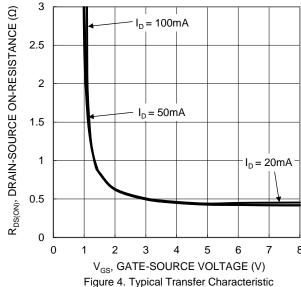


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





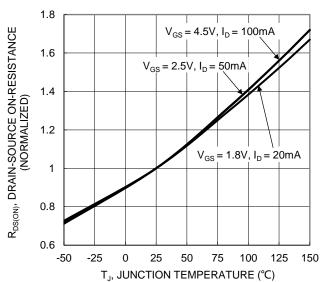


Figure 6. On-Resistance Variation with Junction Temperature





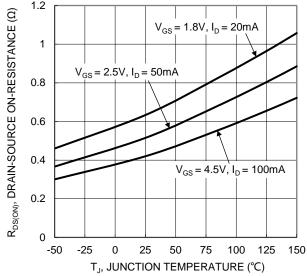


Figure 7. On-Resistance Variation with Junction Temperature

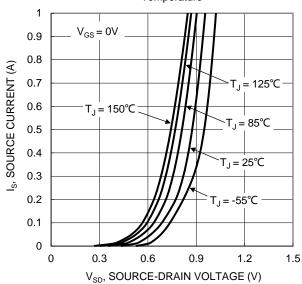


Figure 9. Diode Forward Voltage vs. Current

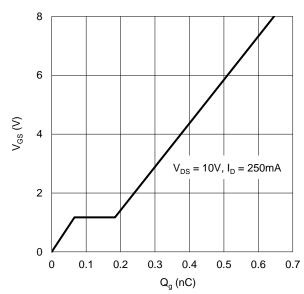


Figure 11. Gate Charge

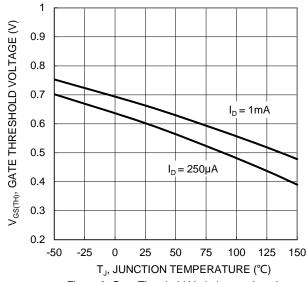


Figure 8. Gate Threshold Variation vs. Junction Temperature

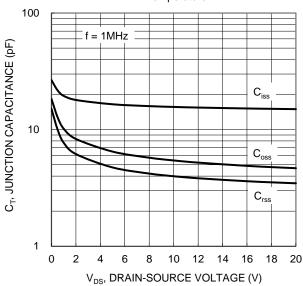


Figure 10. Typical Junction Capacitance

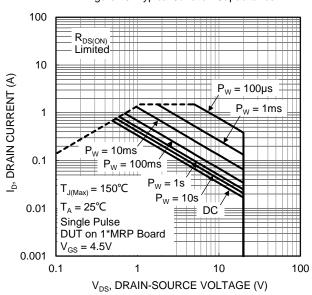


Figure 12. SOA, Safe Operation Area



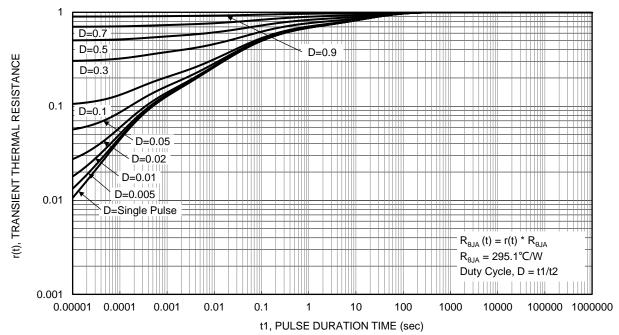


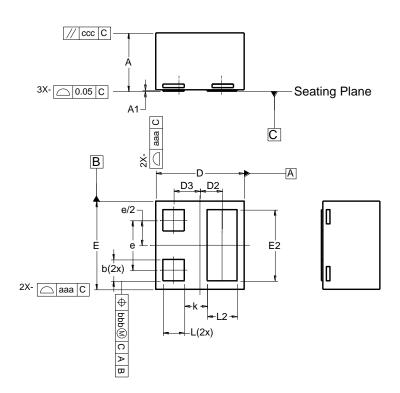
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DFN0606-3

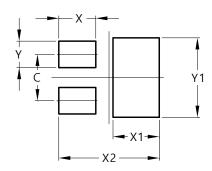


X2-DFN0606-3					
Dim	Min	Max	Тур		
Α	0.36	0.40	0.39		
A1	0.00	0.05	0.02		
b	0.10	0.20	0.15		
D	0.57	0.67	0.62		
D2	0.	155 BS	SC		
D3	0.	185 BS	SC		
E	0.57	0.57 0.67 0.6			
E2	0.40	0.60	0.50		
е	0.35 BSC				
k	0.	.16 RE	F		
L	0.10	0.20	0.15		
L2	0.11	0.31	0.21		
aaa	0.08				
bbb	0.07				
CCC	0.05				
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### X2-DFN0606-3



Dimensions	Value (in mm)		
С	0.350		
Х	0.280		
X1	0.350		
X2	0.760		
Y	0.200		
Y1	0.600		



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